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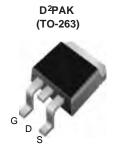
N-Channel 130 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω)	I _D (A)	
130	0.0048 at V _{GS} = 10 V	128 ^a	

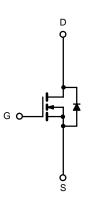
FEATURES

- DT-Trench Power MOSFET
- · New Package with Low Thermal Resistance
- 100 % R_g Tested





Top View



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_{C} = 25 \text{ °C}$, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	130	V			
Gate-Source Voltage	V _{GS}	± 20	v			
Continuous Drain Current ($T_1 = 175 \text{ °C}$)	T _C = 25 °C	1	128 ^a	А		
$Continuous Drain Current (1_j = 175 C)$	T _C = 125 °C	I _D	92 ^a			
Pulsed Drain Current	I _{DM}	460	A			
Avalanche Current	I _{AR}	85				
Repetitive Avalanche Energy ^b	L = 0.1 mH	E _{AR}	280	mJ		
Maximum Power Dissipation ^b	T _C = 25 °C	Р	375 ^c	w		
	T _A = 25 °C	– P _D –	3.95			
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	0.4	0/10			

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.d. When mounted on 1" square PCB (FR-4 material).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V _{DS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	130				
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \ \mu A$	2		4	V	
Gate-Body Leakage				± 100	nA		
		V _{DS} = 100 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50	μA	
		V_{DS} = 100 V, V_{GS} = 0 V, T_{J} = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	120			А	
		V _{GS} = 10 V, I _D = 60 A		0.0048	0.0055	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 125 °C			0.0089		
		V_{GS} = 10 V, I _D = 30 A, T _J = 175 °C			0.0135		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	25			S	
Dynamic ^b	-						
Input Capacitance	C _{iss}			6200		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz		930			
Reverse Transfer Capacitance	C _{rss}			420			
Total Gate Charge ^c	Qg			130	160	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 50$ V, $V_{GS} = 10$ V, $I_{D} = 85$ A		24			
Gate-Drain Charge ^c	Q _{gd}			24			
Gate Resistance	Rg		1.0		6.2	Ω	
Turn-On Delay Time ^c	t _{d(on)}			20	30		
Rise Time ^c	t _r	V_{DD} = 50 V, R_{L} = 0.6 Ω		125	200	20	
Turn-Off Delay Time ^c	t _{d(off)}	$\text{I}_\text{D}\cong$ 85 A, V_GEN = 10 V, R_g = 2.5 Ω		55	85	ns	
Fall Time ^c	t _f			130	195		
Source-Drain Diode Ratings and Ch	aracteristics 7	$\Gamma_{\rm C} = 25 \ ^{\circ}{\rm C}^{\rm b}$					
Continuous Current	۱ _S				118	^	
Pulsed Current	I _{SM}				440	A	
Forward Voltage ^a	V _{SD}	$I_{F} = 85 \text{ A}, \text{ V}_{GS} = 0 \text{ V}$		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			70	140	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	I _F = 50 A, dl/dt = 100 A/µs		5.5	10	Α	
Reverse Recovery Charge	Q _{rr}			0.19	0.35	μC	

Notes:

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



6 V $V_{GS} = 10 \text{ V}$ thru 7 I_D - Drain Current (A) I_D - Drain Current (A) . T_C = 125 °C 5 V - 55 °C 25 °C 4 V V_{DS} - Drain-to-Source Voltage V_{GS} - Gate-to-Source Voltage (V) **Output Characteristics Transfer Characteristics** 0.015 $T_C = -55 \ ^\circ C$ 0.012 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance ($\Omega)$ g_{fs} - Transconductance (S) 25 °C 0.009 V_{GS} = 10 V 125 °C 0.006 0.003 0.000 I_D - Drain Current (A) I_D - Drain Current (A) Transconductance **On-Resistance vs. Drain Current** 10 000 V_{DS} = 50 V I_D = 85 A V_{GS} - Gate-to-Source Voltage (V) C_{iss} C - Capacitance (pF) C_{oss} Q_g - Total Gate Charge (nC) V_{DS} - Drain-to-Source Voltage (V)

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

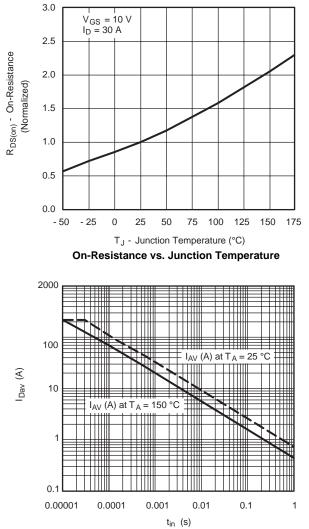
Capacitance



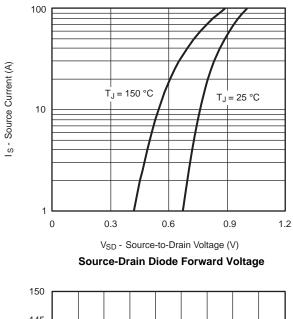
Gate Charge

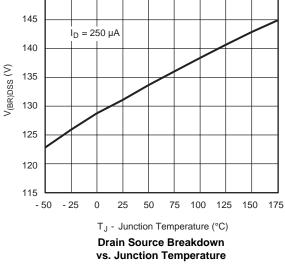
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Avalanche Current vs. Time

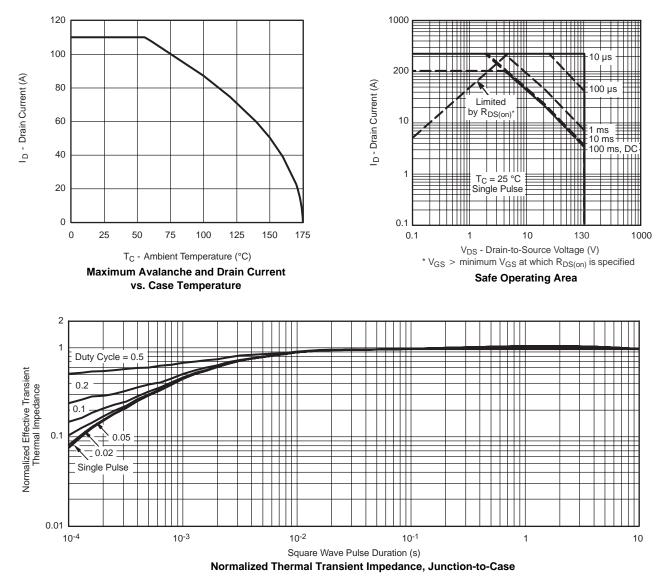






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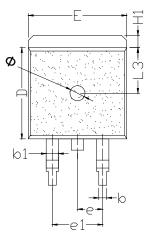
THERMAL RATINGS

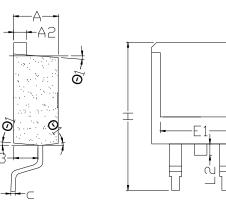


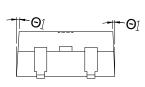


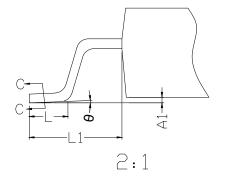
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TO-263 PACKAGE OUTLINE









COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

А

SYMBOL	MIN	TYP	MAX	SYMBOL	MIN	TYP	MAX
А	4.10	4.50	4.80	е	2.35	2.54	2.75
A1	0.00	0.10	0.30	e1	5.08REF		
A2	1.10	1.30	1.50	Н	14.50	15.15	16.00
A3	2.15	2.50	3.10	H1	1.00	1.28	1.75
b	0.60	0.80	1.05	L	1.80	2.23	2.90
b1	1.05	1.33	1.50	L1	4.30	4.75	5.50
с	0.33	0.50	0.66	L2	1.00	1.30	1.85
D	8.40	9.20	9.60	L3	0.90	4.65	9.00
D1	7.50REF		ф	0°	2°	5°	
E	9.60	10.02	10.80	φ1	2°	-	7°
E1	7.60	9.88	10.30	Φ		1.5BSC	



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